

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | | |
|---|-----------------|----------------------------------|------------------|--------------|----|
| Drain-Source Voltage | | | V _{DSS} | 30 | V |
| Gate-Source Voltage | | | V _{GSS} | ±20 | V |
| Continuous Proin Current (Note 6) Vos - 40V | Steady State | $T_A = +25$ °C $T_A = +70$ °C | ID | 1000 900 | mA |
| Continuous Drain Current (Note 6) V _{GS} = 10V | t < 5s | $T_A = +25$ °C $T_A = +70$ °C | ID | 1300 1000 | mA |
| Maximum Continuous Body Diode Forward Curren | I _S | 0.5 | Α | | |
| Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%) | | | I _{DM} | 9.6 | Α |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit | |
|---|------------------------|-----------------------------------|-------------|------|--|
| Total Power Dissipation (Note 5) | T _A = +25°C | P _D | 0.32 | W | |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | $R_{\theta JA}$ | 395 | °C/W | |
| Total Power Dissipation (Note 6) | T _A = +25°C | P _D | 0.4 | W | |
| Thermal Resistance, Junction to Ambient (Note 6) Steady State | | $R_{\theta JA}$ | 320 | °C/W | |
| Thermal Resistance, Junction to Case | R _{0JC} | 143 | | | |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C | |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|----------------------|---------------------|-----|------|-----|------|---|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | | | |
| Drain-Source Breakdown Voltage | | BV _{DSS} | 30 | _ | _ | V | $V_{GS} = 0V$, $I_D = 1mA$ | |
| Zero Gate Voltage Drain Current @ | $T_C = +25^{\circ}C$ | IDSS | - | _ | 1 | μΑ | $V_{DS} = 30V$, $V_{GS} = 0V$ | |
| Gate-Source Leakage | | I _{GSS} | 1 | | ±10 | μA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | | | |
| Gate Threshold Voltage | | V _{GS(TH)} | 1.5 | _ | 2.8 | V | $V_{DS} = V_{GS}$, $I_D = 250\mu A$ | |
| Static Drain-Source On-Resistance | | D- a (a) iii | - | 122 | 190 | mΩ | $V_{GS} = 10V, I_D = 1.3A$ | |
| Static Drain-Source On-Nesistance | | R _{DS(ON)} | 1 | 181 | 335 | | $V_{GS} = 4.5V, I_D = 290mA$ | |
| Diode Forward Voltage | | V_{SD} | | | 1.2 | V | $V_{GS} = 0V, I_S = 250mA$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | | |
| Input Capacitance | | C _{iss} | - | 87 | _ | pF | V _{DS} = 20V, V _{GS} = 0V, -f = 1.0MHz | |
| Output Capacitance | | Coss | 1 | 17 | _ | pF | | |
| Reverse Transfer Capacitance | | C _{rss} | | 12 | _ | pF | | |
| Gate Resistance | | R_g | 1 | 69.8 | - | Ω | $f = 1MHz$, $V_{GS} = 0V$, $V_{DS} = 0V$ | |
| Total Gate Charge (V _{GS} = 4.5V) | | Q_g | | 0.9 | _ | nC | V _{DS} = 10V, I _D = 250mA | |
| Total Gate Charge (V _{GS} = 10V) | | Q_g | _ | 2.0 | _ | nC | | |
| Gate-Source Charge | | Q_{gs} | _ | 0.3 | _ | nC | | |
| Gate-Drain Charge | | Q_{gd} | _ | 0.3 | _ | nC | | |
| Turn-On Delay Time | | t _{D(ON)} | _ | 4.5 | _ | ns | $V_{DD} = 30V, V_{GS} = 10V,$ $R_{G} = 10\Omega, I_{D} = 100mA$ | |
| Turn-On Rise Time | | t _R | _ | 8.9 | _ | ns | | |
| Turn-Off Delay Time | | t _{D(OFF)} | | 30.3 | _ | ns | | |
| Turn-Off Fall Time | | t _F | | 15.6 | _ | ns | | |

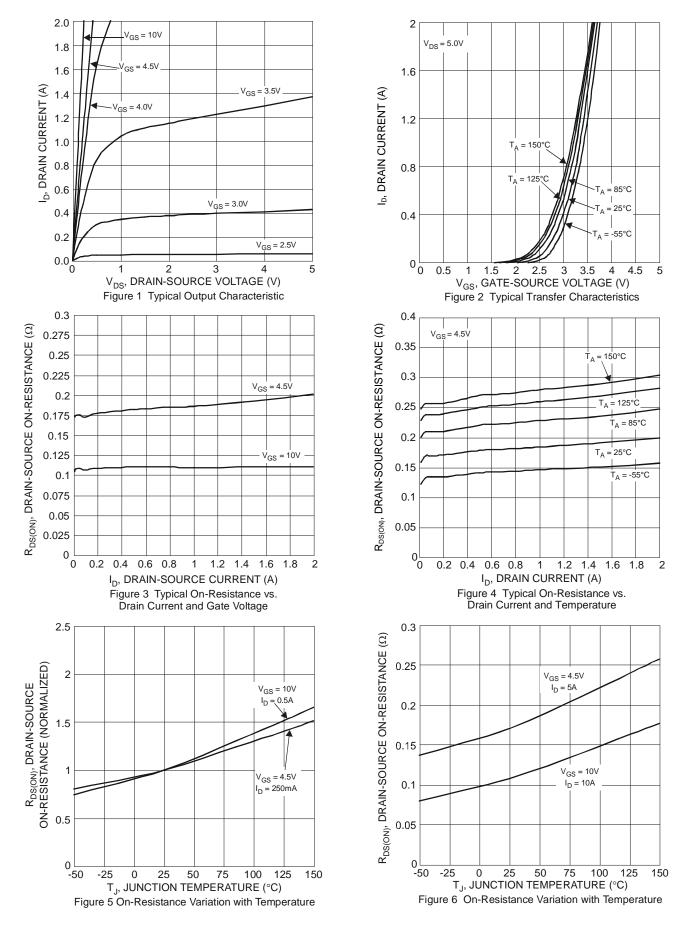
Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

^{6.} Device mounted on 1" × 1" FR-4 PCB with high coverage 2oz. Copper, single sided.

^{7.} Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.







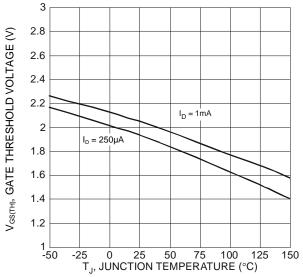
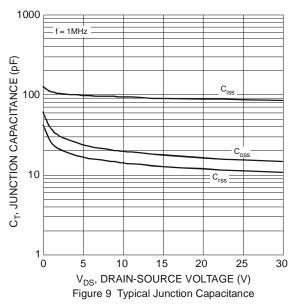
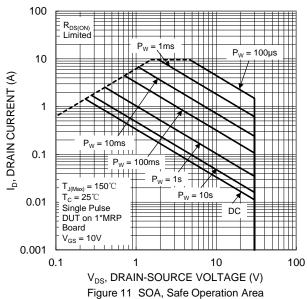
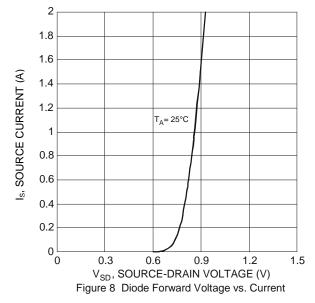
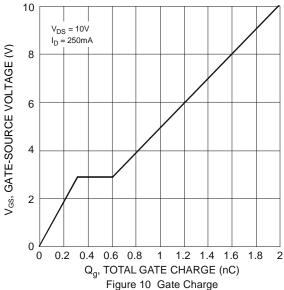


Figure 7 Gate Threshold Variation vs. Junction Temperature







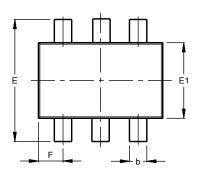


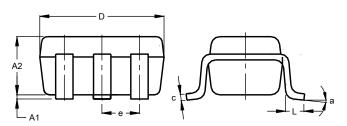


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



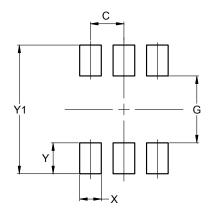


| SOT363 | | | | | |
|----------------------|-----------|------|-------|--|--|
| Dim | Min | Max | Тур | | |
| A1 | 0.00 | 0.10 | 0.05 | | |
| A2 | 0.90 | 1.00 | 0.95 | | |
| b | 0.10 | 0.30 | 0.25 | | |
| U | 0.10 | 0.22 | 0.11 | | |
| D | 1.80 | 2.20 | 2.15 | | |
| Е | 2.00 | 2.20 | 2.10 | | |
| E1 | 1.15 | 1.35 | 1.30 | | |
| е | 0.650 BSC | | | | |
| F | 0.40 | 0.45 | 0.425 | | |
| L | 0.25 | 0.40 | 0.30 | | |
| а | 0° | 8° | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



| Dimensions | Value (in mm) | | |
|------------|------------------|--|--|
| С | 0.650 | | |
| G | 1.300 | | |
| Х | 0.420 | | |
| Y | 0.600 | | |
| Y1 | 2.500 | | |



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